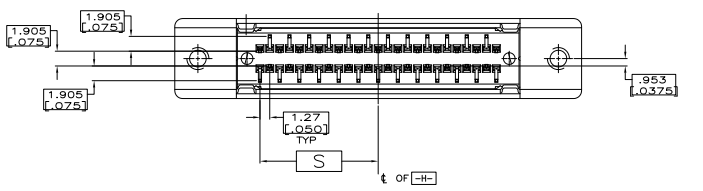
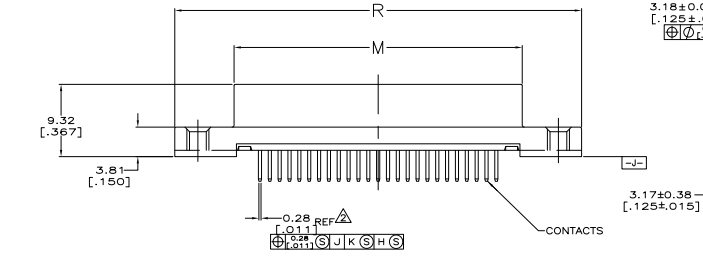


P.C. BOARD MOUNTING DIMENSIONS
(CONNECTOR SIDE)



- △ FINISH
 CONTACTS: EITHER GOLD PLATED 0.76µm [.000030] MIN ON MATING END OR GOLD FLASH OVER PALLADIUM NICKEL 0.76µm [.000030] MIN TOTAL ON MATING END. TIN-LEAD PLATED 3.05µm [.000120] MIN ON SOLDER LEAD, ALL OVER 1.27µm [.000050] MIN NICKEL UNDERPLATE.
 BRACKET: NICKEL PLATED.
- △ POSITION TOLERANCE APPLIES AT TIP ONLY.
- △ MATERIAL
 CONTACTS: PHOSPHOR BRONZE.
 HOUSING: UL V-0 RATED POLYESTER LCP COLOR BLACK.
 BRACKET: ZINC.
- △ ACTUAL HOLE SIZE USED WILL DEPEND ON TRACE ROUTING REQUIREMENTS BETWEEN HOLES AND CONNECTOR PLACEMENT TECHNIQUE.

50 POSITION AS SHOWN

X	31.11	64.20	62.23	66.60	68.94	78.23	100	749085-9
	1.225	3.315	2.450	2.622	2.714	3.080		
Y	15.24	52.45	30.48	34.85	37.19	46.48	50	749085-5
	.600	2.065	1.200	1.372	1.464	1.830		
PIN BOARD	S	R	P	N	M	L	NO. OF POSN.	PART NUMBER

THIS DRAWING IS A CONTROLLED DOCUMENT. IN STOCK 1-3-81
 DESIGNED BY J. W. BOOTH 1-3-81
 DRAWING NO. 749085-9
 CHECKED BY J. W. BOOTH 1-3-81
 APPROVED BY J. W. BOOTH 1-3-81
 TYS ELECTRONICS CORPORATION
 HARRISBURG, PA 17105-3608
 PLUS ASSEMBLY, SHIELDED, VERTICAL, AMP/LIMIT 150 Series
 DATE: 08/07/79
 DRAWING NO: 749085
 CUSTOMER DRAWING
 SHEET 4.1 OF 1